## 35 V, 5 A, Low V<sub>CE(sat)</sub> PNP Transistor

ON Semiconductor's  $e^2$ PowerEdge family of low V<sub>CE(sat)</sub> transistors are miniature surface mount devices featuring ultra low saturation voltage (V<sub>CE(sat)</sub>) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical application are DC–DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e<sup>2</sup>PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

### Features

- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant\*

#### **MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$ )

Rating	Symbol	Max	Unit	
Collector-Emitter Voltage	V <sub>CEO</sub>	-35	Vdc	
Collector-Base Voltage	V <sub>CBO</sub>	-55	Vdc	
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	Vdc	
Collector Current – Continuous	Ι <sub>C</sub>	-2.0	Adc	
Collector Current – Peak	I <sub>CM</sub>	-5.0	А	
Electrostatic Discharge	ESD	HBM Class 3 MM Class C		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

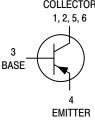


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# $\begin{array}{c} 35 \text{ VOLTS} \\ 5.0 \text{ AMPS} \\ \\ \text{PNP LOW } V_{\text{CE(sat)}} \text{ TRANSISTOR} \\ \\ \text{EQUIVALENT } R_{\text{DS(on)}} \text{ 100 } \text{m}\Omega \end{array}$





## MARKING DIAGRAM



VS8 = Device Code M = Date Code\*

= Pb–Free Package

(\*Note: Microdot may be in either location)

\*Date Code orientation may vary depending upon manufacturing location.

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NSS35200MR6T1G	TSOP-6 (Pb-Free)	3,000 / Tape & Reel
SNSS35200MR6T1G	TSOP-6 (Pb-Free)	3,000 / Tape & Reel

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P <sub>D</sub> (Note 1)	625 5.0	mW mW/°C
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub> (Note 1)	200	°C/W
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P <sub>D</sub> (Note 2)	1.0 8.0	W mW/°C
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub> (Note 2)	120	°C/W
Thermal Resistance, Junction-to-Lead #1	R <sub>θJL</sub>	80	°C/W
Total Device Dissipation (Single Pulse < 10 sec.)	P <sub>Dsingle</sub> (Notes 2 & 3)	1.75	W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

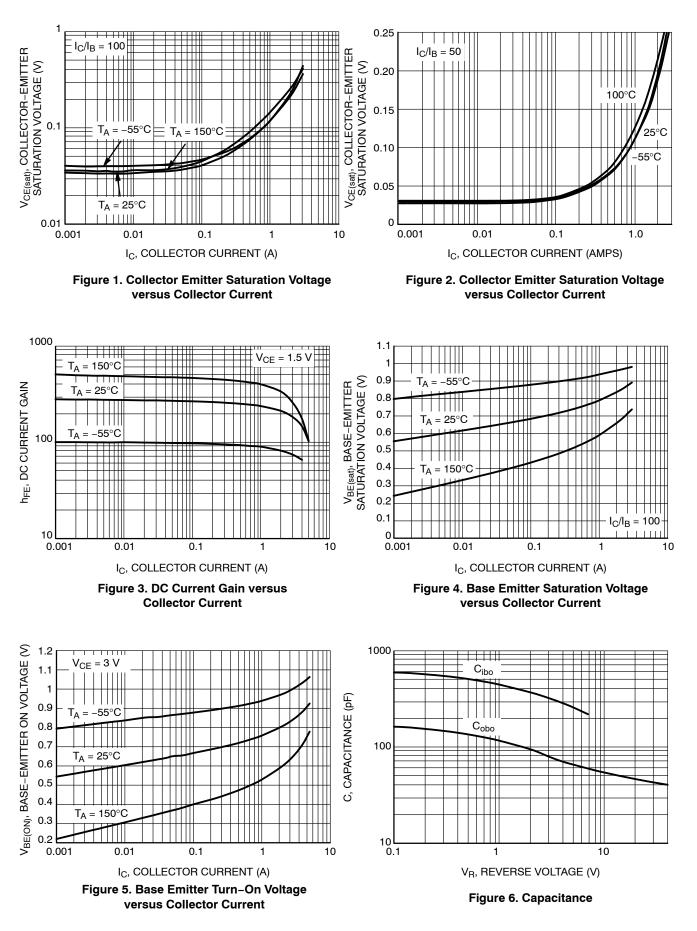
FR-4 @ Minimum Pad.
FR-4 @ 1.0 X 1.0 inch Pad.
Refer to Figure 8.

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = $25^{\circ}$ C unless otherwise noted)

Characteristic	Symbol	Min	Typical	Max	Unit
OFF CHARACTERISTICS	·				
Collector – Emitter Breakdown Voltage $(I_C = -10 \text{ mAdc}, I_B = 0)$	V <sub>(BR)CEO</sub>	-35	-45	-	Vdc
Collector – Base Breakdown Voltage $(I_C = -0.1 \text{ mAdc}, I_E = 0)$	V <sub>(BR)CBO</sub>	-55	-65	_	Vdc
Emitter – Base Breakdown Voltage ( $I_E = -0.1 \text{ mAdc}, I_C = 0$ )	V <sub>(BR)EBO</sub>	-5.0	-7.0	_	Vdc
Collector Cutoff Current ( $V_{CB} = -35$ Vdc, $I_E = 0$ )	I <sub>CBO</sub>	_	-0.03	-0.1	μAdc
Collector-Emitter Cutoff Current (V <sub>CES</sub> = -35 Vdc)	I <sub>CES</sub>	_	-0.03	-0.1	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = -4.0 Vdc)	I <sub>EBO</sub>	_	-0.01	-0.1	μAdc
ON CHARACTERISTICS	•		•	•	*
DC Current Gain (Note 4)	h <sub>FF</sub>				

DC Current Gain (Note 4) ( $I_C = -1.0 \text{ A}, V_{CE} = -1.5 \text{ V}$ ) ( $I_C = -1.5 \text{ A}, V_{CE} = -1.5 \text{ V}$ ) ( $I_C = -2.0 \text{ A}, V_{CE} = -3.0 \text{ V}$ )	h <sub>FE</sub>	100 100 100	200 200 200	_ 400 _	
Collector – Emitter Saturation Voltage (Note 4) ( $I_C = -0.8 \text{ A}, I_B = -0.008 \text{ A}$ ) ( $I_C = -1.2 \text{ A}, I_B = -0.012 \text{ A}$ ) ( $I_C = -2.0 \text{ A}, I_B = -0.02 \text{ A}$ )	V <sub>CE(sat)</sub>	- - -	-0.125 -0.175 -0.260	-0.15 -0.20 -0.31	V
Base – Emitter Saturation Voltage (Note 4) ( $I_C = -1.2 \text{ A}, I_B = -0.012 \text{ A}$ )	V <sub>BE(sat)</sub>	-	-0.68	-0.85	V
Base – Emitter Turn–on Voltage (Note 4) ( $I_C = -2.0 \text{ A}, V_{CE} = -3.0 \text{ V}$ )	V <sub>BE(on)</sub>	_	-0.81	-0.875	V
Cutoff Frequency ( $I_C = -100 \text{ mA}$ , $V_{CE} = -5.0 \text{ V}$ , f = 100 MHz)	f <sub>T</sub>	100	_	_	MHz
Input Capacitance (V <sub>EB</sub> = -0.5 V, f = 1.0 MHz)	Cibo	-	600	650	pF
Output Capacitance (V <sub>CB</sub> = -3.0 V, f = 1.0 MHz)	Cobo	-	85	100	pF
Turn–on Time (V <sub>CC</sub> = –10 V, I <sub>B1</sub> = –100 mA, I <sub>C</sub> = –1 A, R <sub>L</sub> = 3 $\Omega$ )	t <sub>on</sub>	-	35	-	nS
Turn–off Time (V_{CC} = –10 V, I_{B1} = I_{B2} = –100 mA, I_{C} = 1 A, R_{L} = 3 $\Omega$ )	t <sub>off</sub>	-	225	-	nS

4. Pulsed Condition: Pulse Width = 300  $\mu$ sec, Duty Cycle  $\leq$  2%.



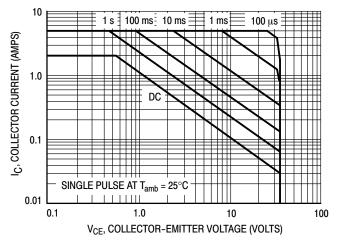


Figure 7. Safe Operating Area

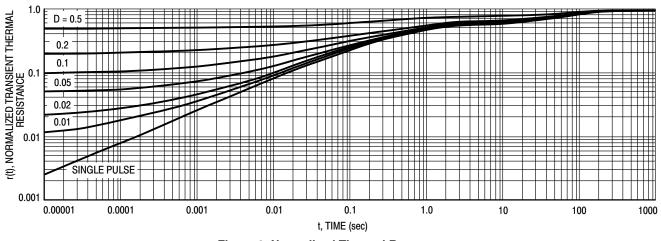


Figure 8. Normalized Thermal Response





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